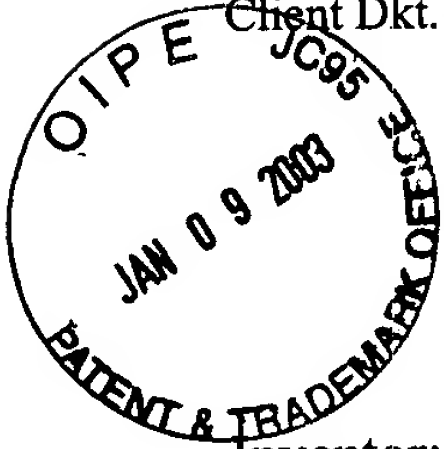


Inventor: Henry Johnson
Serial No.: 09/752,658
Client Dkt. No. H0001540 (4960)

Art Unit: 2827
Examiner: David Graybill



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231**

RECEIVED
JAN 15 2003
TECHNOLOGY CENTER 2800

Inventor: **Henry Johnson**

Examiner: David Graybill
Art Unit: 2827

Serial No: **09/752,658**

Client Docket No.: H0001540 (4960)
Attorney Docket No.: 100665.0021US1

Filed: **December 28, 2000**

For: **Layered Circuit Boards and
Methods of Production Thereof**

RESPONSE TO OFFICE ACTION

Assistant Commissioner for Patents
Washington, D.C. 20231

Dear Sir:

This paper responds to the Office Action dated October 21, 2002. Please enter the following:

IN THE CLAIMS

Amend claim 2 as follows:

2. The sublamination material of claim 1, wherein the material consists essentially of the two signal layers, the reference layer, the cured core material, the cured bond-ply, and the at least one via, and wherein the material is not coupled to any other layers.